DECEARATION FOR PA	IENT APPLICATION		Docket Number Optional)
As a below named inventor, 1 hereby declare that:			MR3315-3
My residence, post office addre	ss and citizenship are as s	stated below next to r	ny name.
I believe I am the original, first and so names are listed below) of the subje MANUFACTURING METHOD NANOPARTICLES COMPONE	ct matter which is claimed and FOR POLYMER CHIPS CO NT	for which a patent is so ONTAINING METAL	ught on the invention entitled
, the specification of which is attach			
		• •	er or PCT International Application
Number	and was ame		(if applicable).
I hereby state that I have reviewed a amended by any amendment refer		the above identified spe	ecilication, including the daims, as
I acknowledge the duty to disclose inf I hereby claim foreign priority benefits certificate, or § 365(a) of any PCT Inter below and have also identified below, International application having a filing Prior Foreign Application(s)	ormation which is material to pa under 35 U.S.C. § 119(a)-(d) or national application which design by checking the box, any foreic	 § 365(b) of any foreign a nated at least one country in application for patent o 	application(s) for patent or inventor's other than the United States, listed or inventor's certificate, or PCT
Fibir degit Application(s)			Fronty Not Claimed
(Number)	(Country)	(Day/Month/Yea	ar Filed)
(Number)	(Country)	(Day/Month/Yea	
I hereby claim the benefit under 35 U	S.C § 11 9(e) of any United Sta	tes provisional applicatio	n(s) listed below.
(Application Number)	(Filing D	ate)	
(Application Number)	(Filing D	ate)	
in the prior United States or PCT Intel I acknowledge the duty to disclose info between the filing date of the prior app (Application Number)	rmation which is material to pate	ntability as defined in 37 C International filing date o	CFR § 1.56 which became available
(Application Number)	(Filing Date)		is-patented, pending, abandoned)
I hereby appoint the following attorney	/(s) and/or agent(s) to prosecute	e this application and to tr	ansactall business in the Patent and))49; DAVID R. WOOD, #53,868;
HARRY L. SERNAKER, #50,595	: DAVIDIKI FIN ESO REC	3 #33 253: JUNY I FF	F ESO REG #40262
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I hereby declare that all statements m belief are believed to be true., and furt like so made are punishable by fine or in	ade herein of my own knowled her that these statements were	ge are true and that all st made with the knowledo	ge that willful false statements and the
willful false statements may jeopardiz	e the validity of the application of	any patent issued there	on.
Full name of sole or first invento	or (given name, family nam	e) SHIN-HSIN (CHANG (CHANG IS FAMILY NAME
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Additional Inventors ate being named on separately numbered sheets attached hereto.